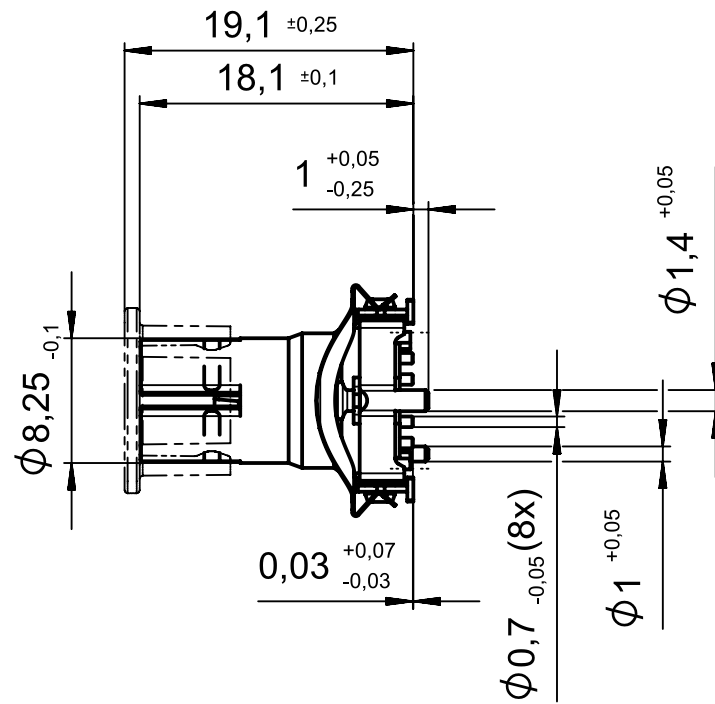
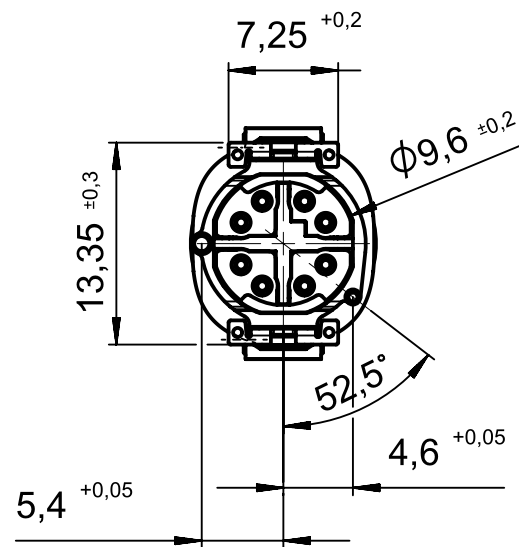
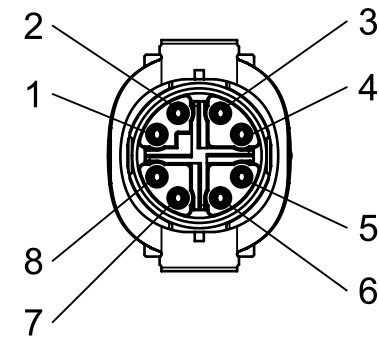


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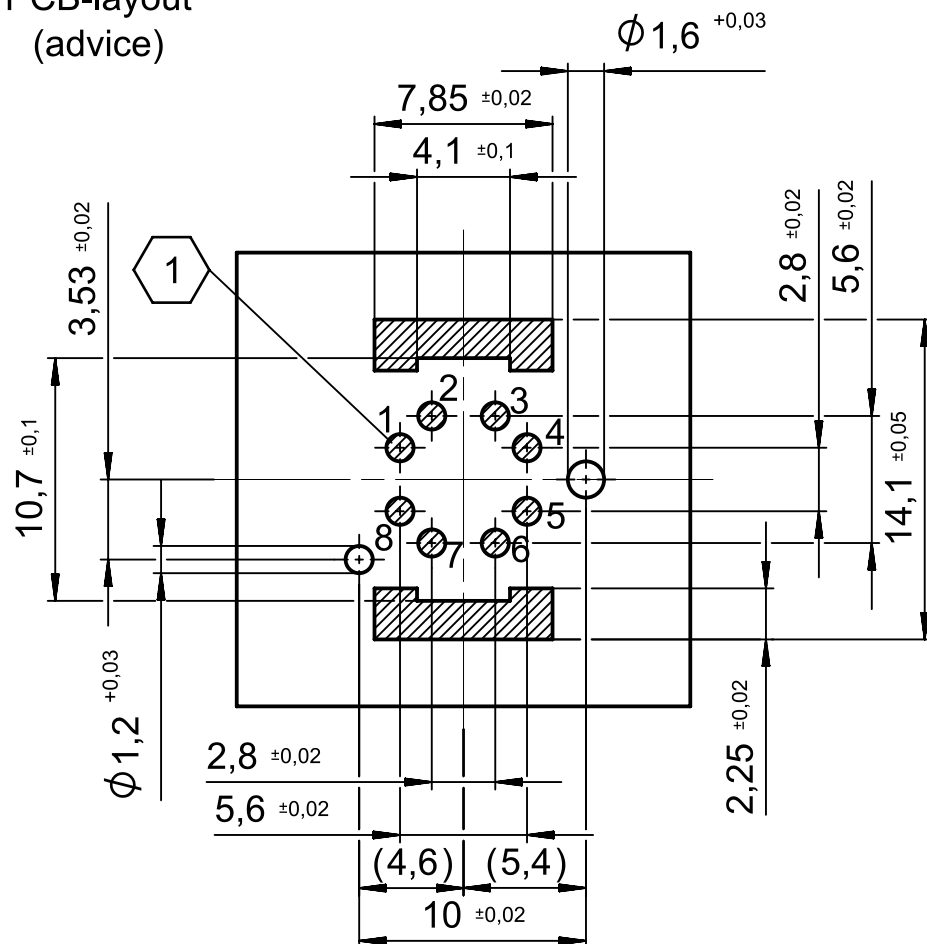
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socket face female



PCB-layout
(advice)



Coplanarity of all contacts and anchor plate  0.1

Recommended solder paste thickness 150µm

 Further information on soldering process and recommended layout, see brochure "Connectors for SMT production"

- EN ISO 291 23/50

 DIN A3			document-no. / ri 103180428 / 00	article-no. / ri 1081252/09	scale 2:1	- Simplified representation - Linear dimensions (mm)
			date 2026-05-28	document-type TECDOC 2D-Productdrawing		
			description SACC-CI-M12FSX-8P SMD SH R32PD			
page	1	of	1			